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Infineon Technologies BFQ 19S E6327

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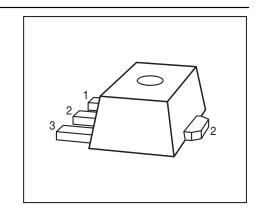




BFQ19S

Low Noise Silicon Bipolar RF Transistor

- For low noise, low distortion broadband amplifiers in antenna and telecommunications systems up to 1.5 GHz at collector currents from 10 mA to 70 mA
- Pb-free (RoHS compliant) package
- Qualification report according to AEC-Q101 available





ESD (Electrostatic discharge) sensitive device, observe handling precaution!

| Туре | Marking | Pin Configuration | | | Package |
|--------|---------|-------------------|-------|-------|---------|
| BFQ19S | FG | 1 = B | 2 = C | 3 = E | SOT89 |

Maximum Ratings at T_A = 25 °C, unless otherwise specified

| Parameter | Symbol | Value | Unit |
|---------------------------------------|--------------------|---------|------|
| Collector-emitter voltage | V_{CEO} | 15 | V |
| Collector-emitter voltage | V_{CES} | 20 | |
| Collector-base voltage | V_{CBO} | 20 | |
| Emitter-base voltage | V_{EBO} | 3 | |
| Collector current | I _C | 120 | mA |
| Base current | l _B | 12 | |
| Total power dissipation ¹⁾ | P _{tot} | 1 | W |
| <i>T</i> _S ≤ 85°C | | | |
| Junction temperature | T_{J} | 150 | °C |
| Ambient temperature | T _A | -65 150 | |
| Storage temperature | T_{Stq} | -65 150 | |

Thermal Resistance

| Parameter | Symbol | Value | Unit |
|--|-------------------|-------|------|
| Junction - soldering point ²⁾ | R _{thJS} | 65 | K/W |

 $^{{}^1}T_{
m S}$ is measured on the collector lead at the soldering point to the pcb

 $^{^{2}}$ For the definition of R_{thJS} please refer to Application Note AN077 (Thermal Resistance Calculation)



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Datasheet of BFQ 19S E6327 - TRANSISTOR RF NPN 15V SOT-89

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Electrical Characteristics at T_A = 25 °C, unless otherwise specified

| Parameter | Symbol | | Values | /alues | |
|---|----------------------|------|---------------|--------|----|
| | | min. | typ. | max. | |
| DC Characteristics | | | | | • |
| Collector-emitter breakdown voltage | V _{(BR)CEO} | 15 | - | - | ٧ |
| $I_{\rm C} = 1 \text{ mA}, I_{\rm B} = 0$ | . , | | | | |
| Collector-emitter cutoff current | I _{CES} | - | - | 10 | μΑ |
| $V_{CE} = 20 \text{ V}, V_{BE} = 0$ | | | | | |
| Collector-base cutoff current | I _{CBO} | - | - | 100 | nA |
| $V_{\rm CB} = 10 \text{ V}, I_{\rm E} = 0$ | | | | | |
| Emitter-base cutoff current | I _{EBO} | - | - | 100 | μΑ |
| $V_{\rm EB} = 2 \text{ V}, I_{\rm C} = 0$ | | | | | |
| DC current gain | h _{FE} | 70 | 100 | 140 | - |
| $I_{\rm C}$ = 70 mA, $V_{\rm CE}$ = 8 V, pulse measured | | | | | |





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| Parameter | Symbol | | Values | | Unit |
|--|-------------------|------|--------|------|------|
| | | min. | typ. | max. | |
| AC Characteristics (verified by random sampling | ıg) | | | | |
| Transition frequency | f _T | 4 | 5.5 | - | GHz |
| $I_{\rm C}$ = 70 mA, $V_{\rm CE}$ = 8 V, f = 500 MHz | | | | | |
| Collector-base capacitance | C _{cb} | - | 1.05 | 1.35 | pF |
| $V_{\text{CB}} = 10 \text{ V}, f = 1 \text{ MHz}, V_{\text{BE}} = 0$, | | | | | |
| emitter grounded | | | | |] |
| Collector emitter capacitance | C _{ce} | - | 0.4 | - | |
| $V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$, | | | | | |
| base grounded | | | | | |
| Emitter-base capacitance | C _{eb} | - | 3.9 | - | 1 |
| $V_{\text{EB}} = 0.5 \text{ V}, f = 1 \text{ MHz}, V_{\text{CB}} = 0$, | | | | | |
| collector grounded | | | | | |
| Minimum noise figure | NF _{min} | | | | dB |
| $I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 6 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$, | | | | | |
| f = 900 MHz | | - | 1.8 | - | |
| f = 1.8 GHz | | - | 3 | _ | |
| Power gain, maximum available ¹⁾ | G _{ma} | | | | 1 |
| $I_{\rm C}$ = 70 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$, $Z_{\rm L}$ = $Z_{\rm Lopt}$, | | | | | |
| f = 900 MHz | | - | 11.5 | - | |
| f = 1.8 GHz | | - | 7 | _ | |
| Transducer gain | $ S_{21e} ^2$ | | | | dB |
| $I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω , | | | | | |
| f = 900 MHz | | _ | 9.5 | _ | |
| f = 1.8 GHz | | _ | 4 | _ | |
| Third order intercept point at output ²⁾ | IP ₃ | - | 32 | - | dBm |
| $V_{CE} = 8 \text{ V}, I_{C} = 70 \text{ mA}, Z_{S} = Z_{Sopt}, Z_{L} = Z_{Lopt},$ | | | | | |
| f = 1.8 GHz | | | | | |
| 1dB Compression point | P _{-1dB} | - | 22 | - | 1 |
| $V_{CE} = 8 \text{ V}, I_{C} = 70 \text{ mA}, Z_{S} = Z_{Sopt}, Z_{L} = Z_{Lopt},$ | | | | | |
| f = 1.8 GHz | | | | | |

 $^{^{1}\}mathsf{G}_{\mathsf{ma}} = |\mathsf{S}_{21}/\mathsf{S}_{12}| \; (\mathsf{k}\text{-}(\mathsf{k}^{2}\text{-}1)^{1/2})$

²IP3 value depends on termination of all intermodulation frequency components.

Termination used for this measurement is 50Ω from 0.2 MHz to 12 GHz

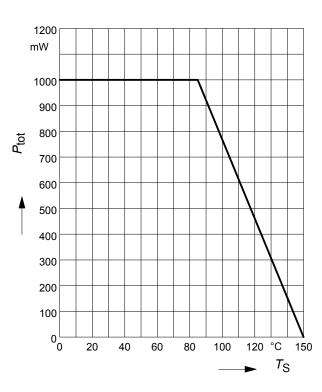


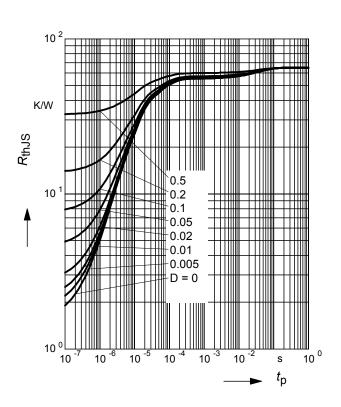


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Total power dissipation $P_{tot} = f(T_S)$

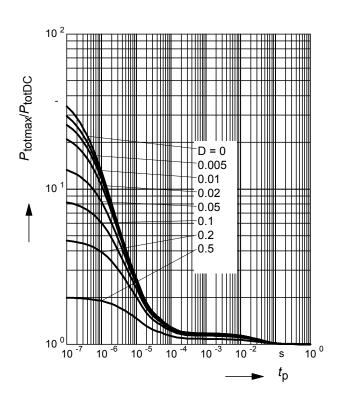
Permissible Pulse Load $R_{thJS} = f(t_p)$





Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_{p})$





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SPICE GP model

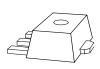
For the SPICE model as well as for S-parameters (including noise parameters) please refer to our internet website www.infineon.com/rf.models. Please consult our website and download the latest versions before actually starting your design.

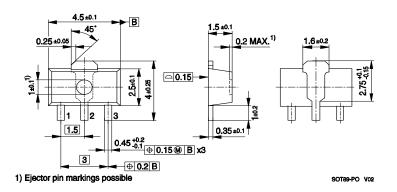


Package SOT89

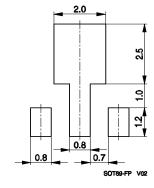
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Package Outline

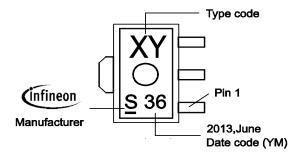




Foot Print

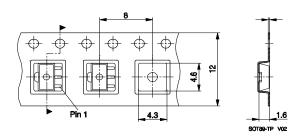


Marking Layout (Example)



Standard Packing

Reel Ø 180 mm= 1.000 Pieces/Reel Reel Ø 330 mm= 4.000 Pieces/Reel



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